



24th Systems and Software Product Line Conference Montréal, Canada October 19-23, 2020 www.splc2020.net

The Systems and Software Product Line Conference (SPLC) is a premier forum where researchers, practitioners, and educators can present and discuss the most recent ideas, trends, experiences, and challenges in the area of software and system product lines engineering. Conference events include opportunities to hear industry leaders' real-world experiences and researchers' latest ideas and to learn from both. The 24th International Systems and Software Product Line Conference (SPLC 2020) will be held from October 19th to 23rd in Montreal, Canada.

Call for Research Papers: Submit high quality research work that uses established scientific methodologies, written using high standards of academic technical publications. **Deadline**: April 17, 2020.

Call for Industrial Systems and Software Product Lines Papers: Present challenges, innovations and solutions to concrete industrial applications of software and product line engineering methodologies and tools. Submitted papers should showcase a significant software component to the research. **Deadline:** April 17, 2020.

Call for Challenges: Propose concrete case studies and problems that showcase SPL-related challenges to be tackled by the SPL community. The accepted challenges will be published followed by a call for solutions. Both accepted challenges descriptions and solutions will be included in the conference proceedings. **First Deadline:** February 7, 2020.

Call for Journal First Papers: Authors of journal-first papers are invited to submit their publications to present their work at SPLC. This is an opportunity to speak directly to the community and offer SPLC attendees a richer set of presentations. Deadline: June 5, 2020.

Call for Workshop Proposals: We invite the community to submit proposals for one or two- day workshops in the field. In particular, workshops on challenging, emerging areas related to conference topics. **Deadline**: March 20, 2020.

Call for Demonstrations and Tools: This track highlights live demonstrations of product-line tools and of practices tackling current industrial challenges. **Deadline:** June 5, 2020.

Call for Doctoral Symposium Papers: This track highlights doctoral proposals, both early and mid- phase, to be reviewed and commented on by a panel of experts. **Deadline:** June 5, 2020.

Call for Tutorial Proposals: Tutorials provide a valuable opportunity for participants to expand their knowledge and skills in product line engineering. Tutorials may focus on introductory product lines topics, or on advanced tools, approaches, methods, and best practices. **Deadline:** March 20, 2020.

Organization Committees

General	Chair
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Roberto E. Lopez-Herrejon, ÉTS, Canada

D	W. I.I. I.
Research Track Chairs	Workshop chairs
Sarah Nadi, University of Alberta, Canada	Iris Reinhartz-Berger, University of Haifa, Israel
Philippe Collet, Université Côte d'Azur, France	Gilles Perrouin, University of Namur, Belgium
Industrial Systems and Software Product Lines Chairs	Tutorials Chairs
Salvador Trujillo, IKERLAN Research Center, Spain	Carlos Cetina, University San Jorge, Spain
Shaukat Ali, Simula Research Laboratory, Norway	Sandro Schulze, University of Magdeburg, Germany
Doctoral Symposium Chairs	Challenge Track Chairs
Rafael Capilla, Universidad Rey Juan Carlos, Spain	Jose Galindo, University of Seville, Spain
Ina Schaefer, Braunschweig University of	Lukas Linsbauer, Johannes Kepler University Linz,
Technology, Germany	Austria
Journal First Chairs	Demonstrations and Tools Chairs
Thorsten Berger, Chalmers University, Sweden	Julia Rubin, University of British Columbia, Canada
Wesley K. G. Assunção, Federal University of Technology – Paraná, Brazil	Jacob Krüger, University of Magdeburg, Germany
Hall of Fame chairs	Proceedings chair
Natsuko Noda, Shibaura Institute of Technology,	Paul Gazzillo, University of Central Florida, USA
Japan	
Goetz Botterweck, University of Limerick, Ireland	
Publicity chair	
Jabier Martinez, Tecnalia, Spain	